

SMT Pick and Place Nozzle for SAMSUNG TN65

This is a high-precision SMT pick and place nozzle designed for SAMSUNG TN65 series automated assembly systems. It is engineered for reliable component handling during PCB assembly, ensuring accurate placement and minimizing downtime.



Product Overview

High-Precision SMT Assembly Nozzle

This high-precision pick and place nozzle is specifically engineered for automated SMT assembly systems. Built for reliability and durability, it ensures accurate component handling and consistent performance during high-speed PCB production. Its design focuses on dimensional stability to minimize downtime and optimize assembly throughput.

Compatibility

Supported Machine Series

SAMSUNG CP45, SAMSUNG CP45 NEO, SAMSUNG CP60

Nozzle Specifications

Available Nozzle Configurations

Part Number	Series	Tip Diameter (Outer/Inner)
J7055246A	CP45	Ø0.8 / Ø0.28
J7055267A	CP45	Ø0.75 / Ø0.38
J7055131C	CP45	Ø1.2 / Ø0.65
J7055132C	CP45	Ø2.2 / Ø1.4
J7055133C	CP45	Ø3.6 / Ø2.2
J7055135C	CP45	Ø6.2 / Ø4.0
J7055137C	CP45	Ø9.0 / Ø7.5
J9055133B	CP45 NEO	Ø0.8 / Ø0.28
J9055134B	CP45 NEO	Ø0.75 / Ø0.38
J9055073C	CP60	Ø3.6 / Ø2.2
J9055074C	CP60	Ø6.2 / Ø4.0